

## Silicon Carbide Power Schottky Diode

### Features

- Industry's leading low leakage currents
- 175 °C maximum operating temperature
- Temperature independent switching behavior
- Superior surge current capability
- Positive temperature coefficient of  $V_F$
- Extremely fast switching speeds
- Superior figure of merit  $Q_C/I_F$

$V_{RRM}$	=	1200 V
$I_F (T_c = 25^\circ C)$	=	25 A
$I_F (T_c \leq 150^\circ C)$	=	10 A
$Q_C$	=	31 nC

### Package



TO - 220AC

### Advantages

- Low standby power losses
- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Low reverse recovery current
- Low device capacitance
- Low reverse leakage current at operating temperature

### Applications

- Power Factor Correction (PFC)
- Switched-Mode Power Supply (SMPS)
- Solar Inverters
- Wind Turbine Inverters
- Motor Drives
- Induction Heating
- Uninterruptible Power Supply (UPS)
- High Voltage Multipliers

### Maximum Ratings at $T_j = 175^\circ C$ , unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit
Repetitive peak reverse voltage	$V_{RRM}$		1200	V
Continuous forward current	$I_F$	$T_c = 25^\circ C$	25	A
Continuous forward current	$I_F$	$T_c \leq 150^\circ C$	10	A
RMS forward current	$I_{F(RMS)}$	$T_c \leq 150^\circ C$	17	A
Surge non-repetitive forward current, Half Sine Wave	$I_{F,SM}$	$T_c = 25^\circ C, t_p = 10\text{ ms}$ $T_c = 150^\circ C, t_p = 10\text{ ms}$	65 55	A
Non-repetitive peak forward current	$I_{F,max}$	$T_c = 25^\circ C, t_p = 10\text{ }\mu s$	280	A
$I^2t$ value	$\int i^2 dt$	$T_c = 25^\circ C, t_p = 10\text{ ms}$ $T_c = 150^\circ C, t_p = 10\text{ ms}$	21 15	$A^2s$
Power dissipation	$P_{tot}$	$T_c = 25^\circ C$	190	W
Operating and storage temperature	$T_j, T_{stg}$		-55 to 175	°C

### Electrical Characteristics at $T_j = 175^\circ C$ , unless otherwise specified

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Diode forward voltage	$V_F$	$I_F = 10\text{ A}, T_j = 25^\circ C$	1.5	1.8	2.6	V
		$I_F = 10\text{ A}, T_j = 175^\circ C$			3.0	
Reverse current	$I_R$	$V_R = 1200\text{ V}, T_j = 25^\circ C$	5	50	10	$\mu A$
		$V_R = 1200\text{ V}, T_j = 175^\circ C$			100	
Total capacitive charge	$Q_C$	$I_F \leq I_{F,MAX}$ $dI_F/dt = 200\text{ A}/\mu s$ $T_j = 175^\circ C$	$V_R = 400\text{ V}$ $V_R = 960\text{ V}$	31 52		nC
Switching time	$t_s$		$V_R = 400\text{ V}$ $V_R = 960\text{ V}$	< 25		
Total capacitance	$C$	$V_R = 1\text{ V}, f = 1\text{ MHz}, T_j = 25^\circ C$ $V_R = 400\text{ V}, f = 1\text{ MHz}, T_j = 25^\circ C$ $V_R = 1000\text{ V}, f = 1\text{ MHz}, T_j = 25^\circ C$	490			pF
			45			
			33			

### Thermal Characteristics

Thermal resistance, junction - case	$R_{thJC}$	0.8	°C/W
-------------------------------------	------------	-----	------

### Mechanical Properties

Mounting torque	M	0.6	Nm
-----------------	---	-----	----

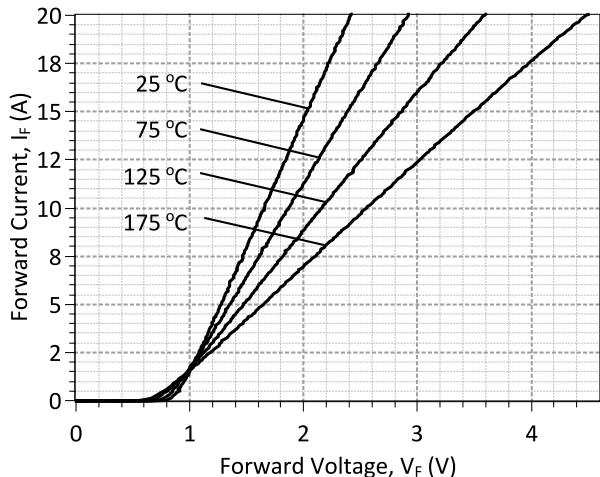


Figure 1: Typical Forward Characteristics

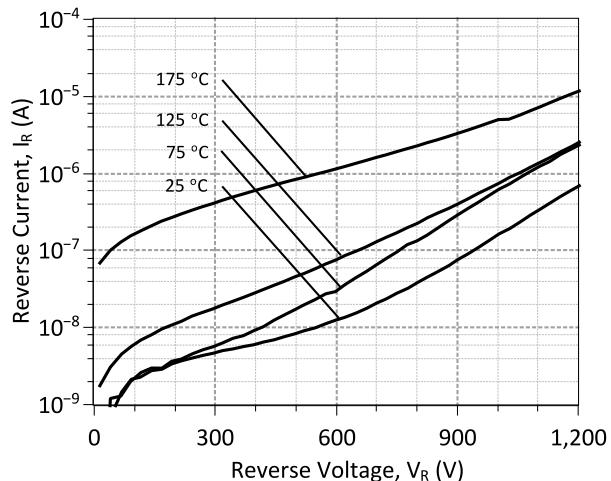


Figure 2: Typical Reverse Characteristics

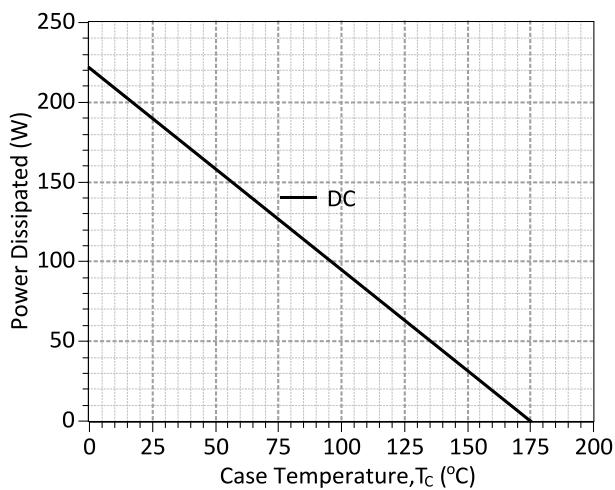


Figure 3: Power Derating Curve

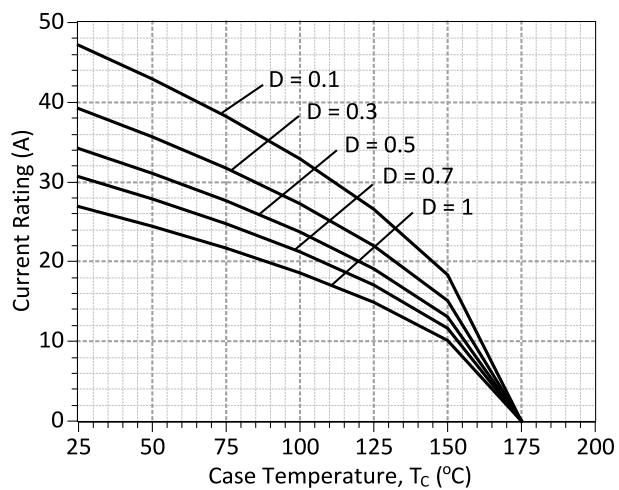


Figure 4: Current Derating Curves ( $D = t_p/T$ ,  $t_p = 400 \mu s$ )  
 (Considering worst case  $Z_{th}$  conditions )

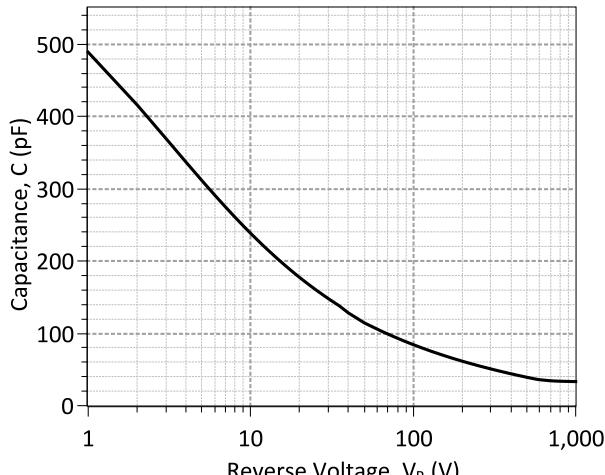


Figure 5: Typical Junction Capacitance vs Reverse Voltage Characteristics

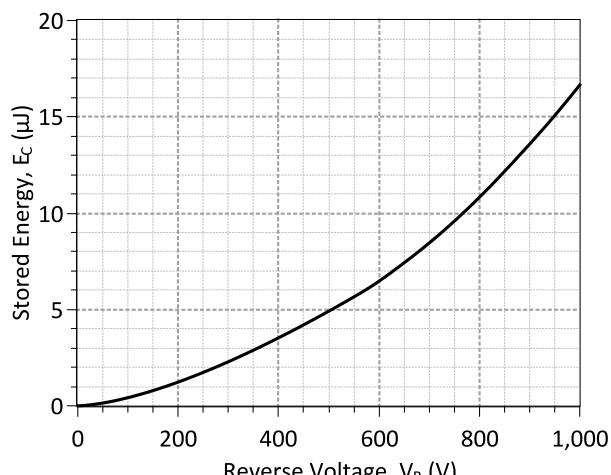


Figure 6: Typical Capacitive Energy vs Reverse Voltage Characteristics

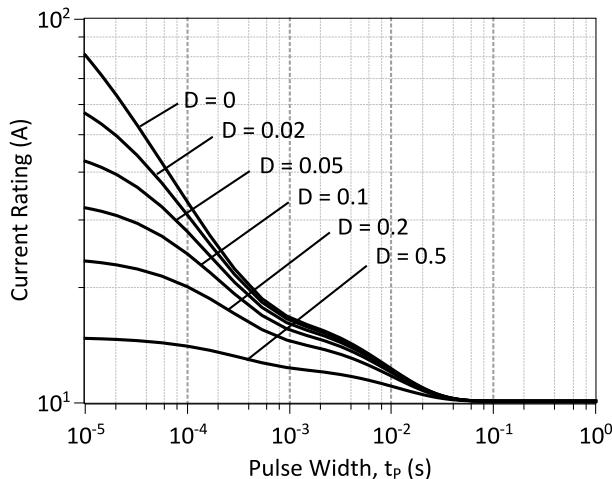


Figure 7: Current vs Pulse Duration Curves at  $T_c = 150 \text{ } ^\circ\text{C}$

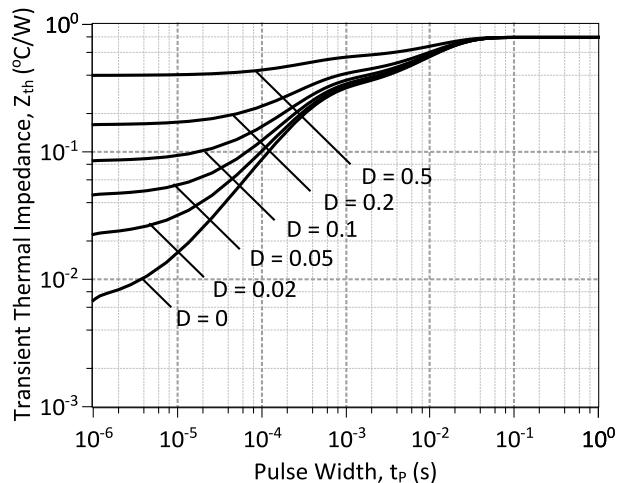
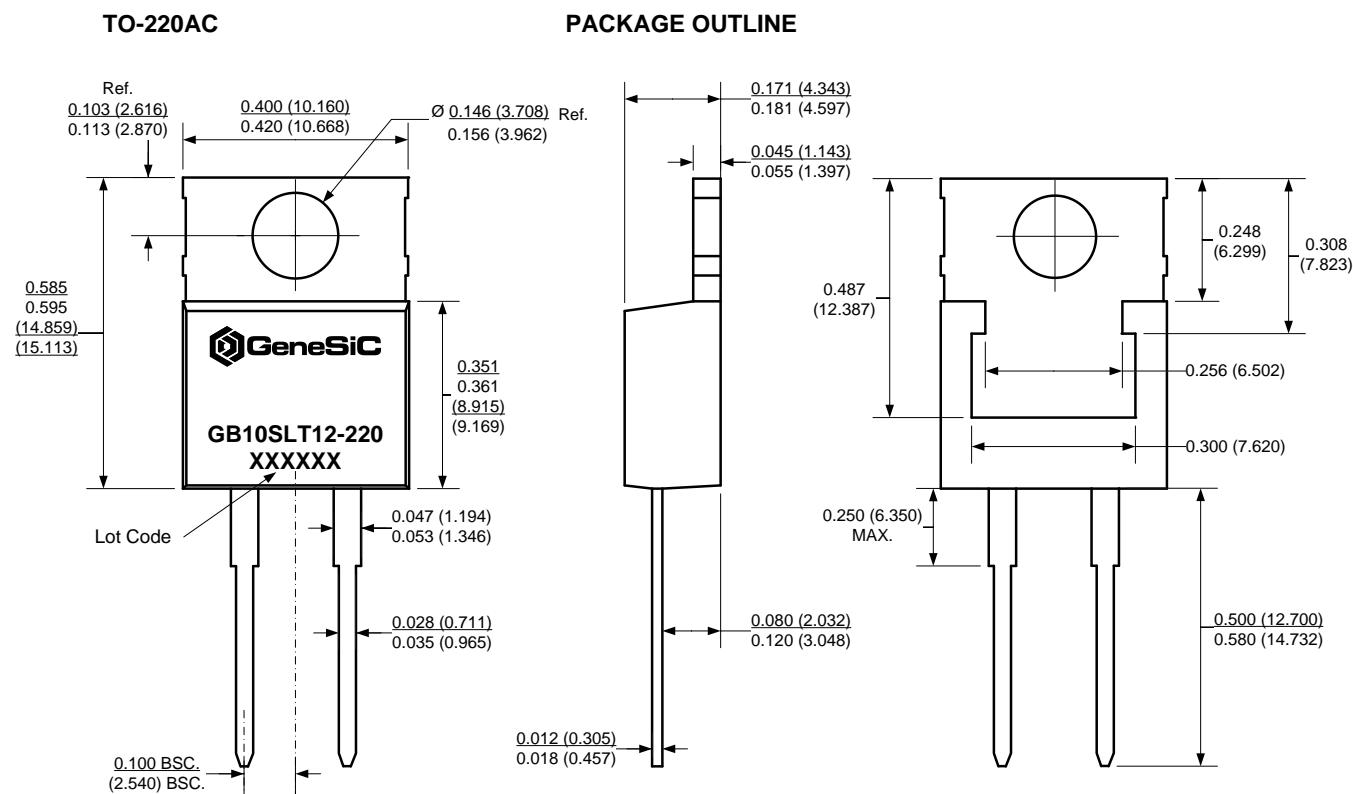


Figure 8: Transient Thermal Impedance

### Package Dimensions:



#### NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS



**GB10SLT12-220**

<b>Revision History</b>			
Date	Revision	Comments	Supersedes
2014/08/26	4	Updated Electrical Characteristics	
2013/06/12	3	Updated Electrical Characteristics	
2012/12/18	2	Second generation update	
2012/05/22	1	Second generation release	
2010/12/14	0	Initial release	

Published by  
GeneSiC Semiconductor, Inc.  
43670 Trade Center Place Suite 155  
Dulles, VA 20166

GeneSiC Semiconductor, Inc. reserves right to make changes to the product specifications and data in this document without notice.

GeneSiC disclaims all and any warranty and liability arising out of use or application of any product. No license, express or implied to any intellectual property rights is granted by this document.

Unless otherwise expressly indicated, GeneSiC products are not designed, tested or authorized for use in life-saving, medical, aircraft navigation, communication, air traffic control and weapons systems, nor in applications where their failure may result in death, personal injury and/or property damage.

## SPICE Model Parameters

This is a secure document. Please copy this code from the SPICE model PDF file on our website ([http://www.genesicsemi.com/images/products\\_sic/rectifiers/GB10SLT12-220\\_SPICE.pdf](http://www.genesicsemi.com/images/products_sic/rectifiers/GB10SLT12-220_SPICE.pdf)) into LTSpice (version 4) software for simulation of the GB10SLT12-220.

```

*      MODEL OF GeneSiC Semiconductor Inc.
*
*      $Revision:    1.0          $
*      $Date:     20-SEP-2013      $
*
*      GeneSiC Semiconductor Inc.
*      43670 Trade Center Place Ste. 155
*      Dulles, VA 20166
*
*      COPYRIGHT (C) 2013 GeneSiC Semiconductor Inc.
*      ALL RIGHTS RESERVED
*
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
*
* Start of GB10SLT12-220 SPICE Model
*
.SUBCKT GB10SLT12 ANODE KATHODE
D1 ANODE KATHODE GB10SLT12_SCHOTTKY
D2 ANODE KATHODE GB10SLT12_PIN
.MODEL GB10SLT12_SCHOTTKY D
+ IS      4.55E-15      RS      0.0736
+ N       1              IKF     1000
+ EG      1.2            XTI     -2
+ TRS1    0.0054347826  TRS2    2.71739E-05
+ CJO     6.40E-10      VJ      0.469
+ M       1.508          FC      0.5
+ TT      1.00E-10      BV      1200
+ IBV    1.00E-03      VPK     1200
+ IAVE   10             TYPE    Sic_Schottky
+ MFG    GeneSiC_Semi
.MODEL GB10SLT12_PIN D
+ IS      1.54E-22      RS      0.19
+ TRS1   -0.004         N       3.941
+ EG      3.23           IKF     19
+ XTI    0               FC      0.5
+ TT      0               BV      1200
+ IBV    1.00E-03      VPK     1200
+ IAVE   10             TYPE    Sic_PiN
.ENDS
*
* End of GB10SLT12-220 SPICE Model

```